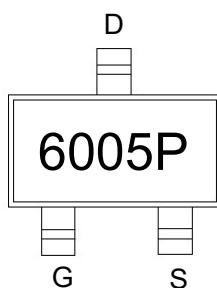


Features

- Excellent package for good heat dissipation
- Ultra low gate charge
- Low reverse transfer capacitance
- Fast switching capability
- Avalanche energy specified

Application

- Power switching application

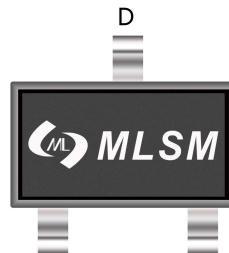


6005P: Device code

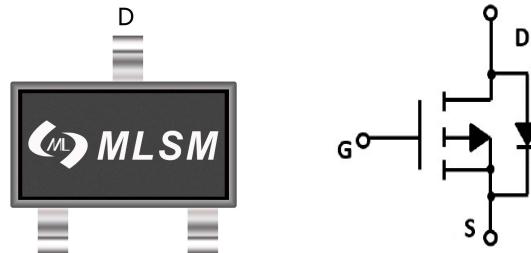
Marking and pin assignment

Product Summary

V_{DS}	$R_{DS(ON)} \text{ MAX}$	$I_D \text{ MAX}$
-60V	90mΩ@-10V	-5A
	130mΩ@-4.5V	



SOT-23-3L top view



Schematic diagram



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V_{DS}	Drain-Source Breakdown Voltage	-60	V
V_{GS}	Gate-Source Voltage	±20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 155	°C
I_S	Diode Continuous Forward Current	Tc=25°C -5	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	Tc=25°C	-20	A
I_D	Continuous Drain Current	Tc=25°C	-5	A
P_D	Maximum Power Dissipation	Tc=25°C	1.2	W
$R_{θJA}$	Thermal Resistance Junction-to-Ambient		113	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLSK6005P	SOT-23-3L	6005P	3,000	45,000	180,000	7" reel

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-60	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-60V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-1.7	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-5A	--	78	90	mΩ
		V _{GS} =-4.5V, I _D =-2A	--	100	130	mΩ

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)

C _{ISS}	Input Capacitance	V _{DS} =-30V, V _{GS} =0V, f=1MHz	--	900	--	pF
C _{OSS}	Output Capacitance		--	112	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	40	--	pF

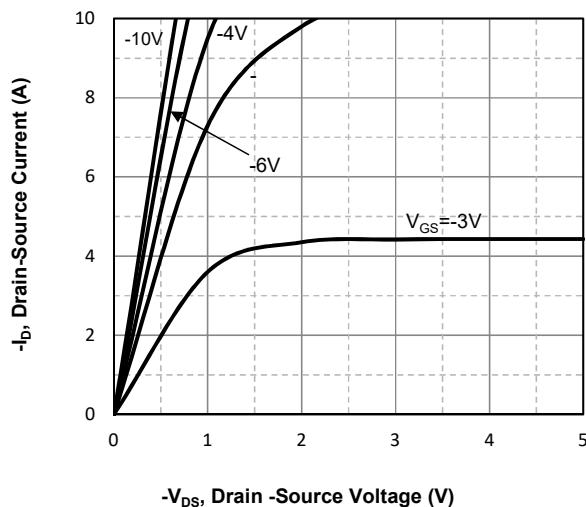
Switching Characteristics

Q _g	Total Gate Charge	V _{DS} =-30V, I _D =-1A, V _{GS} =-10V	--	17.5	--	nC
Q _{gs}	Gate Source Charge		--	3	--	nC
Q _{gd}	Gate Drain Charge		--	3.5	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =-30V, R _L =6Ω, V _{GS} =-10V, R _G =3Ω	--	8	--	nS
t _r	Turn-on Rise Time		--	5	--	nS
t _{d(off)}	Turn-Off Delay Time		--	33	--	nS
t _f	Turn-Off Fall Time		--	8	--	nS

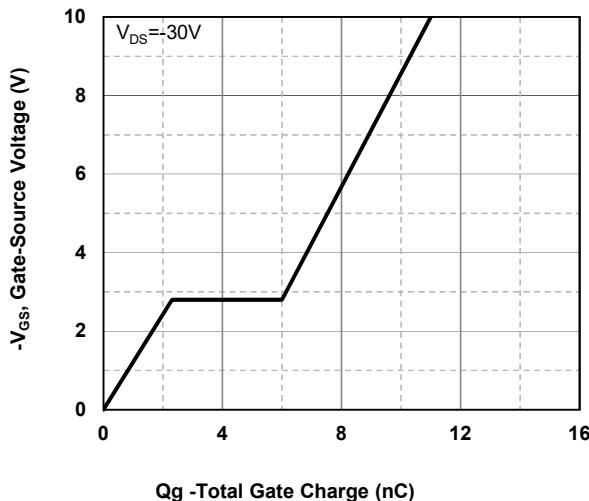
Source- Drain Diode Characteristics

V _{SD}	Forward on voltage	T _j =25°C, I _s =-5A	--	-0.9	-1.2	V
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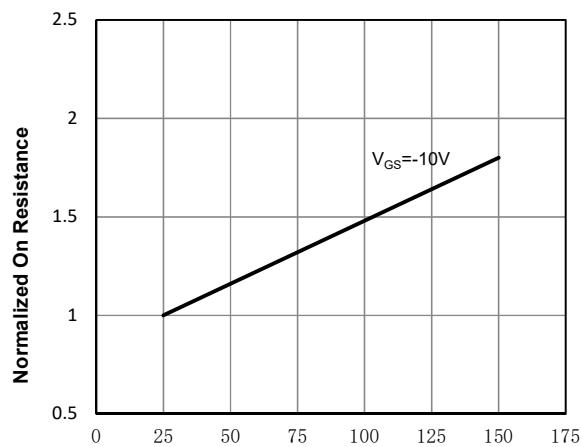
Typical Operating Characteristics



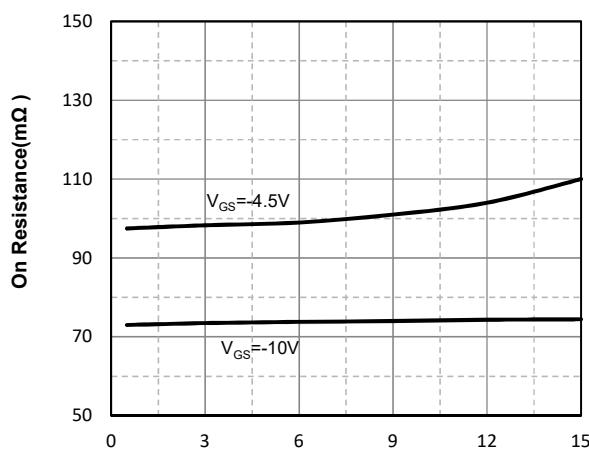
- V_{DS} , Drain -Source Voltage (V)
Fig1. Typical Output Characteristics



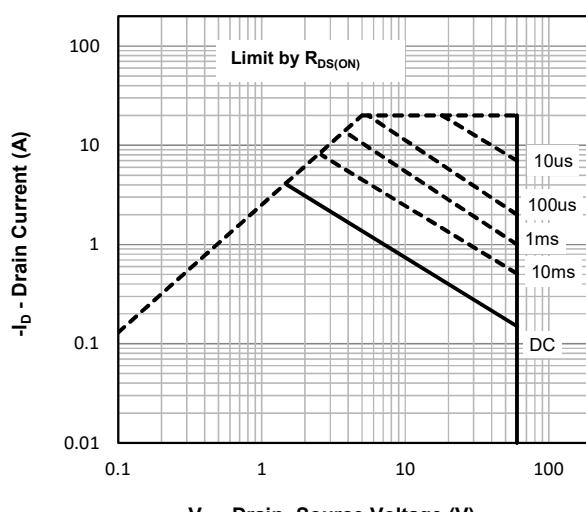
- V_{GS} , Gate-Source Voltage (V)
Fig2. Typical Gate Charge Vs.Gate-Source Voltage



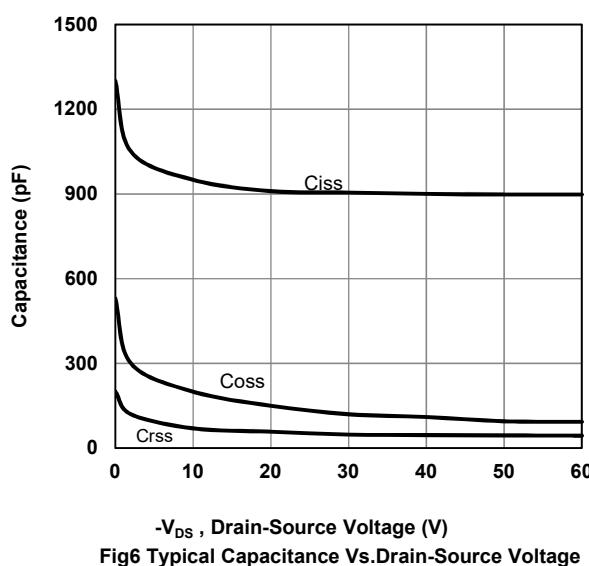
T_j - Junction Temperature (°C)
Fig3. Normalized On-Resistance Vs. Temperature



- I_D , Drain-Source Current (A)
Fig4. On-Resistance Vs. Drain-Source Current

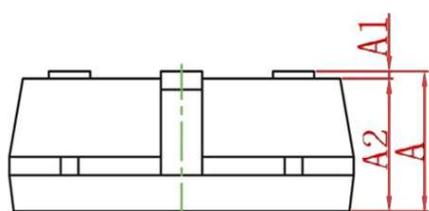
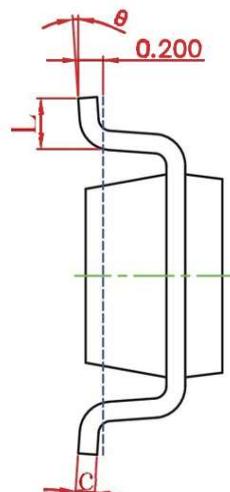
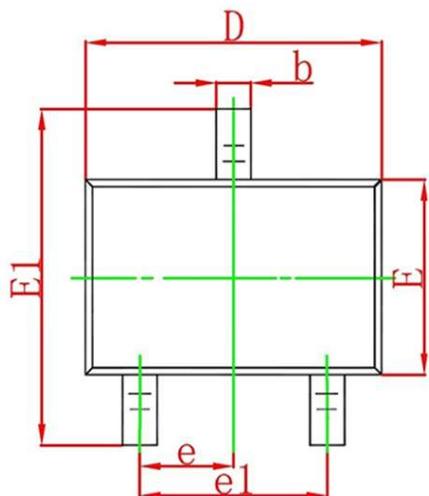


- V_{DS} , Drain -Source Voltage (V)
Fig5. Maximum Safe Operating Area



- V_{DS} , Drain-Source Voltage (V)
Fig6 Typical Capacitance Vs.Drain-Source Voltage

SOT-23-3L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.042	0.050
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.042	0.046
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.112	0.120
E	1.500	1.700	0.060	0.068
E1	2.650	2.950	0.106	0.118
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°